



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**PCN#20240814003.2
Adding CD-PR as additional wafer probe site
Final Change Notification**

Date: August 14, 2024

To: MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

Change Management Team
SC Business Services

20240814003.2

Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
DRV2510QPWPRQ1	NULL
TAS5411QPWPRQ1	NULL
TAS5421QPWPRQ1	NULL

Technical details of this Product Change follow on the next page(s).

PCN Number:	20240814003.2			PCN Date:	August 14, 2024
Title:	Adding CD-PR as additional wafer probe site				
Customer Contact:	Change Management team		Dept:	Quality Services	
Proposed 1st Ship Date:	February 10, 2025		Sample Requests accepted until:	Samples not supported	
Change Type:					
<input type="checkbox"/> Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material	
<input type="checkbox"/> Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site	
<input type="checkbox"/> Mechanical Specification	<input checked="" type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Material	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process	
PCN Details					
Description of Change:					
Texas Instruments Incorporated has qualified CD-PR as additional probe site for the devices listed below to support high volume ramps.					
Current:		New:			
Probe Site	DFAB (DL-LIN)		TI Chengdu (CD-PR)		
Test coverage, insertions, conditions will remain consistent with current testing.					
Reason for Change:					
Enable additional probe capacity to support high volume ramps.					
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):					
None					
Impact on Environmental Ratings					
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.					
RoHS		REACH		Green Status	
<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change	
IEC 62474					
<input checked="" type="checkbox"/> No Change					
Changes to product identification resulting from this PCN:					
None					
Product Affected:					
DRV2510QPWPRQ1	TAS5411QPWPRQ1	TAS5421QPWPRQ1			

ZVEI ID reference: SEM-TF-01

For questions regarding this notice, e-mails can be sent to Change Management team or your local Field Sales Representative.

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